PCI	N Number:	20171005002		PCN Date:	N	November 1		3, 2017	
Title: Datasheet for TPSM84A21									
Customer Contact: PCN Manager						Dept:		Quality Services	
Change Type:									
	Assembly Site			Design					Bump Site
				Data Sheet		Щ		Bump Material	
					art number change				Bump Process
				Test Site					Fab Site
Packing/Shipping/Labeling T			Test Proc	Test Process				Fab Materials	
	Notification Details Wafer Fab Process								
Description of Change:									
Texas Instruments Incorporated is announcing an information only notification.									
The product datasheet(s) is being updated as summarized below.									
The following change history provides further details.									
big Tours									
TEXAS INSTRUMENTS TPSM84A21									
SLVSDF7A - DECEMBER 2016-REVISED JULY 2017									
Changes from Original (December 2016) to Revision A Page									
Deleted Feature MSL 3 / 245°C Peak Reflow									
Added the <i>EMI</i> section									
	datasheet number	will be chang	ging						
Device Family			Change	Change From:			Change To:		
TPSM84A21			SLVSD	SLVSDF7			SLVSDF7A		
These changes may be reviewed at the datasheet links provided.									
http://www.ti.com/product/TPSM84A21									
Reason for Change:									
Improve the device's description and provide better application examples.									
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):									
No	No anticipated impact. This is a specification change announcement only.								
Changes to product identification resulting from this PCN:									
None.									
Pro	duct Affected:								
T	PSM84A21MOJR	TPSM84A21	LMC	TLC					

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com